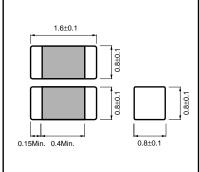
# Multi-layer ceramic chip capacitors

## MCH18 (1608 (0603) size, chip capacitor)

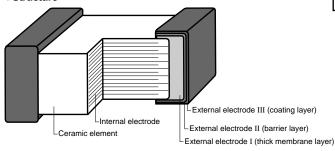
#### Features

- 1) Small size (1.6 x 0.8 x 0.8 mm) makes it perfect for lightweight portable devices.
- 2) Comes packed either in tape to enable automatic mounting or in bulk cases.
- 3) Precise uniformity of shape and dimentions highly efficient automatic mounting.
- 4) Barrier layer and end terminations to improve solderability.

#### ●External dimensions (Units : mm)



#### Structure



#### Product designation

				CC	ae Product thickness	Pace	aging specifications	Reel	Basic ordering (pcs.)
					<b>∢</b> 0.8mm	Paper ta	pe (width 8 mm, pitch 4 mm)	φ180mm (7in.)	4,000
				l l	_ 0.8mm	Paper ta	pe (width 8 mm, pitch 4 mm)	φ330mm (13in.)	16,000
					0.8mm		Bulk case	_	15,000
					e I(\phi180,\phi330mm) lk case :compatible		patible with EIAJ ET-720 EIAJ ET-7201A	00A	
Part No.				Pa	ackaging styl	le			
				_					
			. — — -			=	<u> </u>		
MCH 18 2 FN 104 Z K									
	MI  C  F   I  0  2  F  N  I  U  4  2  K								
	L		التا لگا ا	اكاك ك		ᅹ	•		
			부박		커부	Ŀ			
	<u> </u>				ጟ분	<u> </u>	<u> </u>		
Rated voltage	<u> </u>		acitance-temperature	e characteristics	Nominal	_	acitance tolerance	1	
Rated voltage Code Voltage	Code	Сар		e characteristics Temp. coefficient or percent change	Nominal capacitance	_	acitance tolerance		
		Сар	Operating temperature (°C)			Сар	acitance tolerance		
Code Voltage		Cap	Operating temperature (°C)	Temp. coefficient or percent change		Cap	acitance tolerance tolerance		
Code Voltage 2 25V	Α	Cap Code CG(C0G)	Operating temperature (°C) -55~+125	Temp. coefficient or percent change ±30ppm/°C		Cap Code C	acitance tolerance tolerance ±0.25pF (0.5 ~ 5pF)		
Code Voltage 2 25V 3 16V	Α	Cap Code CG(C0G)	Operating temperature (°C) -55~+125 -55~+125	Temp. coefficient or percent change ±30ppm/°C ±15%	capacitance	Cap Code C D	acitance tolerance tolerance ±0.25pF (0.5 ~ 5pF) ±0.5pF (5.1 ~ 10pF) ±5% (11pF or more)		
Code Voltage 2 25V 3 16V	Α	Cap Code CG(C0G) R B	Operating temperature (°C) -55~+125 -55~+125 -25~+85	Temp. coefficient or percent change ±30ppm/°C ±15% ±10%	capacitance 3-digit designation	Cap Code C	acitance tolerance tolerance ±0.25pF (0.5 ~ 5pF) ±0.5pF (5.1 ~ 10pF)		

## ROHM

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### ●Capacitance range

For thermal compensation

Part num	Temperature			
		MCH18 A (CG) (C0G)		
Capacitance(pF)	characteristics Rated voltage	A (CG) (C0G)		
	Tolerance (V)	50		
0.5		××××		
0.75		<b>******</b>		
1				
1.1				
1.2 1.3		**************************************		
1.5		××××		
1.6				
1.8				
2		×××××		
2.2 2.4	C ( ± 0.25pF)			
2.7		××××××		
3				
3.3		<b>******</b>		
3.6				
3.9 4		**************************************		
4.3		×××××		
4.7		<b>******</b>		
5		<b>******</b>		
5.1				
5.6 6				
6.2				
6.8		<b>******</b>		
7	D ( ± 0.5pF)	<b>*****</b>		
7.5 8	( /	******* *******		
8.2		×××××		
9		<b>*****</b>		
9.1				
10				
11 12				
13		×××××		
15		<b>*****</b>		
16				
18				
20 22		<u>                                   </u>		
24				
27				
30 33				
36	$J$ ( $\pm5\%)$	××××××		
39		×××××		
43				
47		×××××		
51 56				
62				
68				
75				
82 91				
100				

Part nur	MCH18	
	Temperature characteristics	A (CG) (C0G)
Capacitance (pF)	Rated voltage Tolerance (V)	50
110		
120		<b>******</b>
130		<b>******</b>
150		<b>******</b>
160		<b>******</b>
180		<b>******</b>
200		<b>*****</b>
220		
240		
270		<b>******</b>
300	J ( ± 5%)	<b>******</b>
330		<b>*****</b>
360		
390		<u>                                    </u>
430		
470		<b>******</b>
510		
560		
620		<b>******</b>
680		<b>******</b>
750		
820		<b>******</b>
910		
1,000		

Product thickness (mm) 0.8 ± 0.1

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

High dielectric constant

Part num	MCH18					
Capacitance(pF)	Temperature characteristics	CN (R) (B) (X7R)		FN (F) (Y5V)		
Сараснансе(рг)	Rated voltage (V)	50	25	50	25	16
	Tolerance	K (±10%)		Z (+80%, -20%)		%)
220		<b>*****</b>				
270 330		<b>****</b>				
390 470 560		<b>*****</b>				
680 820 1,000						
1,200 1,500 1,800		×××				
2,200 2,700 3,300						
3,900 4,700 5,600				<b>****</b>		
6,800 8,200 10,000 (0.01μF)				<b>****</b>		
12,000 15,000 18,000		<b>****</b>				
22,000 27,000 33,000			<b>****</b>			
39,000 47,000 56,000			<b>****</b>	<b>****</b>		
68,000 82,000					×××	
100,000 (0.1μF) 120,000 150,000 180,000			XXXXXX		XXXXXX	
220,000 270,000 330,000						
390,000 470,000 560,000						
680,000 1,000,000 (1μF) 1,200,000						
1,500,000 1,800,000 2,200,000						

Product thickness (mm) 0.8 ± 0.1

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



#### Characteristics

Class 1 (For thermal compensation)

	Temperature characteristics	A (00) (000)	Test methods / conditions		
Item		A (CG) (C0G)	(based on JIS C 5102)		
Operating temperature		-55°C ~ +125°C			
Nominal capacitance (C)		Must be within the specified tolerance range.	Based on paragraph 7.8 and paragraph 9 Measured at room temperature and standard humidit 1000pF or less Measurement frequency: 1± 0.1MHz		
Dissipation factor $(\tan \delta)$		100 / (400 + 20C)% or less (Less than 30 pF) 0.1% or less (30 pF or larger)	Measurement voltage : 1± 0.1Vrms Over 1000pF Measurement frequency : 1± 0.1Vrms Measurement voltage : 1± 0.1Vrms		
Insulation resistance (IR)		10,000MΩ or 500MΩ μF , whichever is smaller	Based on paragraph 7.6 Measurement is made after rated voltage is applied for 60 ± 5s.		
Withstanding voltage		The insulation must not be damaged.	Based on paragraph 7.1 Apply 300% of the rated voltage for 1 to 5s then measure.		
Temperature ch	haracteristics	Within 0 $\pm$ 30ppm / °C	The temperature coefficients in table 12, paragraph 7.12 are calculated at 20°C and high temperature.		
Terminal adherence		No detachment or signs of detachment.	Based on paragraph 8.11.2 Apply 5N for 10 ± 1s in the direction indicated by the arrow.  Pressure (5N) Capacitor Capacitor		
	Appearance	There must be no mechanical damage.	Chip is mounted to a board in the manner shown on the right, subjected to vibration (type A in paragraph 8.2),		
Resistance to vibration	Rate of capacitance change	Must be within initial tolerance.			
•	Dissipation factor (tanδ)	Must satisfy initial specified value.	and measured 24 ± 2 hrs. later. Board		
Solderability		At least 3 / 4 of the surface of the two terminals must be covered with new solder.	Based on paragraph 8.13 Soldering temperature : $235 \pm 5^{\circ}$ C Soldering time : $2 \pm 0.5$ s		
	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	$\pm2.5\%$ or $\pm0.25~\text{pF}$ , whichever is larger.	Based on paragraph 8.14		
Resistance to soldering	Dissipation factor (tanδ)	Must satisfy initial specified value.	Soldering temperature : $260 \pm 5$ °C Soldering time : $5 \pm 0.5$ s		
heat	Insulation resistance	10,000MΩ or 500MΩ·μF , whichever is smaller	Preheating : 150 ± 10°C for 1 to 2 min.		
	Withstanding voltage	The insulation must not be damaged.	1 0 2 11111.		
Temperature cycling	Appearance	There must be no mechanical damage.			
	Rate of capacitance change	$\pm~2.5\%\pm0.25~\text{pF}$ , whichever is larger.	Based on paragraph 9.3		
	Dissipation factor (tanδ)	Must satisfy initial specified value.	Number of cycles : 5 Capacitance measured after 24 ± 2 hrs.		
	Insulation resistance	10,000MΩ or 500MΩ·μF , whichever is smaller			
Humidity load test	Appearance	There must be no mechanical damage.	Based on paragraph 9.9		
	Rate of capacitance change	$\pm$ 7.5% or $\pm$ 0.75 pF , whichever is larger.	Test temperature : 40 ± 2°C Relative humidity : 90% to 95%		
	Dissipation factor (tanδ)	0.5% or less	Applied voltage : rated voltage Test time : 500 to 524 hrs.		
	Insulation resistance	500M $\Omega$ or 25M $\Omega$ ·μF , whichever is smaller	Capacitance measured after 24 ± 2 hrs.		
	Appearance	There must be no mechanical damage.	Based on paragraph 9.10		
High-	Rate of capacitance change	$\pm$ 3.0% or $\pm$ 0.3 pF , whichever is larger.	Test temperature : Max. operating temp.		
temperature load test	Dissipation factor (tanδ)	0.3% or less	Applied voltage : rated voltage × 200% Test time : 1,000 to 1,048 hrs.		
iodu test	Insulation resistance	1,000M $\Omega$ or 50M $\Omega$ :μF , whichever is smaller	Capacitance measured after 24 ± 2 hrs.		

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#### Class 2 (High dielectric constant)

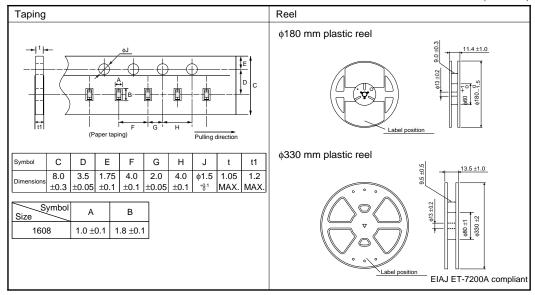
Jiass 2 (High die	iectric constant)					
Temperature characteristics		CN (R) (B) (X7R)	FN (F) (Y5V)	Test methods/conditions (based on JIS C 5102)		
Operating temperature		-55°C ~ +125°C	-30°C ~ +85°C			
Nominal capacitance (C)		Must be within the spe	Based on paragraph 7.8 Measured at room temperature and standard humidity Measurement frequency: 1 ± 0.1 kHz Measurement voltage : 1.0 ± 0.2 Vrms.			
Dissipation factor (tanδ)		2.5% or less 5.0% or less (when rated voltage is 16V: 3.5% or less) (when rated voltage is 16V: 7.5% or less)				
Insulation resistance (IR)		10,000 MΩ or 500 MΩ -	Based on paragraph 7.6 Measurement is made after rated voltage is applied for $60 \pm 5s$ .			
Withstanding voltage		The insulation mus	Based on paragraph 7.1 Apply 250% of the rated voltage for 1 to 5s then measure			
Temperature characteristics		Within ± 15%	+ 22, + 82%	The temperature coefficients in paragraph 7.12, table 8, condition B, are based on measurements carried out at $20^{\circ}\text{C}$ , with no voltage applied.		
Terminal adherence		No detachment or signs of detachment		Based on paragraph 8. 11. 2.  Apply 5N for 10 ± 1s in the direction indicated by the arrow.		
	Appearance	There must be no m	nechanical damage.	Chip is mounted to a board in the		
Resistance to vibration	Rate of capacitance change	Must be within i	initial tolerance.	manner shown on the right, subjected to vibration (type A in paragraph 8.2),		
	Dissipation factor ( $tan\delta$ )	Must satisfy initia	Il specified value.	and measured 48 ± 4 hrs. later. Board		
Solderability		At least 3/4 of the surface of the two terminals must be covered with new solder.		Based on paragraph 8. 13 Soldering temperature: $235 \pm 5^{\circ}$ C Soldering time : $2 \pm 0.5$ s		
	Appearance	There must be no m	nechanical damage.			
	Rate of capacitance change	Within ± 5.0% Within ± 20.0%		Based on paragraph 8. 14.		
Resistance to soldering	Dissipation factor (tanδ)	Must satisfy initia	Il specified value.	Soldering temperature: 260 ± 5°C		
heat	Insulation resistance	10,000M $\Omega$ or 500M $\Omega \cdot \mu F,$ whichever is smaller		$ \begin{array}{lll} \mbox{Soldering time} & : 5 \pm 0.5 \mbox{s} \\ \mbox{Preheating} & : 150 \pm 10^{\circ} \mbox{C for} \\ \mbox{1 to 2 min.} \\ \end{array} $		
	Withstanding voltage	The insulation mus				
	Appearance	There must be no m				
Temperature cycling	Rate of capacitance change	Within ± 7.5%	Within ± 20.0%	Based on paragraph 9.3  Number of cycles : 5		
	Dissipation factor (tanδ)	Must satisfy initial specified value.		Capacitance measured after 48 ± 4		
	Insulation resistance	10,000M $\Omega$ or 500M $\Omega \cdot \mu$				
Humidity load test	Appearance	There must be no m	Based on paragraph 9.9			
	Rate of capacitance change	± 12.5% or less	Within ± 30.0%	Test temperature: 40 ± 2°C		
	Dissipation factor (tanδ)	5.0% or less	7.5% or less (when rated voltage is 16V: 10.0%)	Relative humidity: 90% to 95% Applied voltage : rated voltage Test time : 500 to 524 hrs.		
	Insulation resistance	500M $\Omega$ or 25M $\Omega$ · $\mu$ F, whichever is smaller		Capacitance measured after 48 ± 4 h		
	Appearance	There must be no mechanical damage.				
Ī	Rate of capacitance change	Within ± 10.0%	Within ± 30.0%	Based on paragraph 9.10		
High- temperature load test	Dissipation factor (tanδ)	7.5% or less (when rated voltage is 16V: 10.0%)		Test temperature: Max. operating ten Applied voltage : 210 Test time : 1,000 to 1,048 hrs Capacitance measured after 48 ± 4 h		
			, ,			

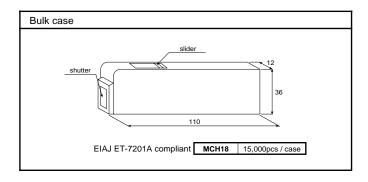
<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



#### Packaging specifications

(Units : mm)





<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### Electrical characteristics

#### ■ A (C0G) Characteristics

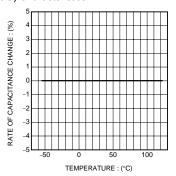


Fig.1 Capacitance - temperature characteristics

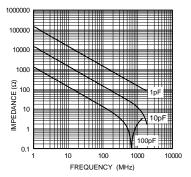


Fig.2 Impedance - frequency characteristics

#### ■CN (X7R) Characteristics

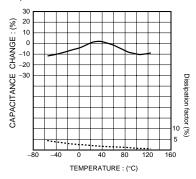


Fig.3 Capacitance - temperature characteristics

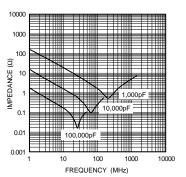


Fig.4 Impedance - frequency characteristics

#### ■FN (Y5V) Characteristics

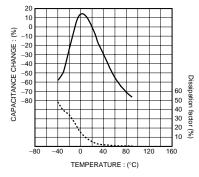


Fig.5 Capacitance - temperature characteristics

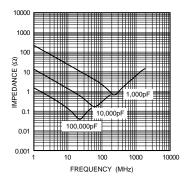
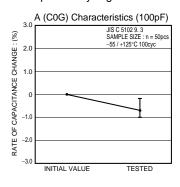


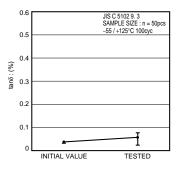
Fig.6 Impedance - frequency characteristics

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.



#### ■ Temperature cycling test





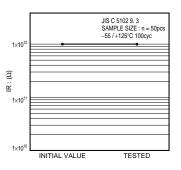
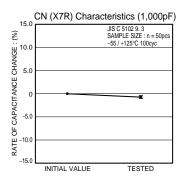
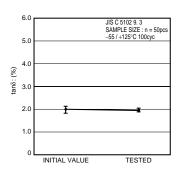


Fig.7 Rate of capacitance change

Fig.8 tanδ

Fig.9 Insulation resistance





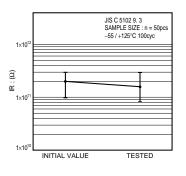
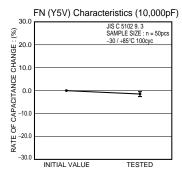
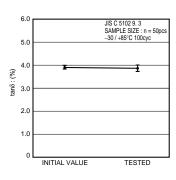


Fig.10 Rate of capacitance change

Fig.11 tanδ

Fig.12 Insulation resistance





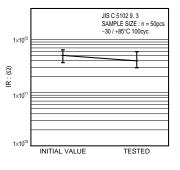


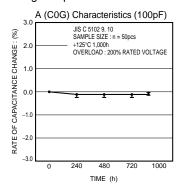
Fig.13 Rate of capacitance change

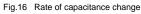
Fig.14 tanδ

Fig.15 Insulation resistance

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

#### ■ High-temperature load test





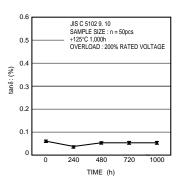


Fig.17 tanδ

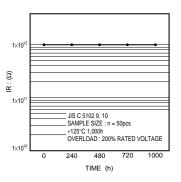


Fig.18 Insulation resistance

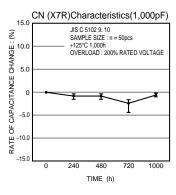


Fig.19 Rate of capacitance change

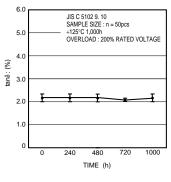


Fig.20  $\tan \delta$ 

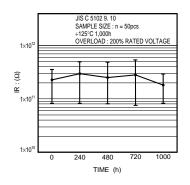


Fig.21 Insulation resistance

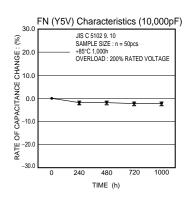


Fig.22 Rate of capacitance change

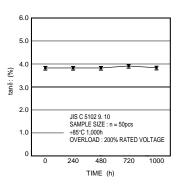


Fig.23  $tan\delta$ 

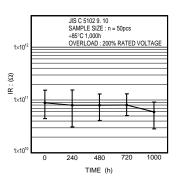
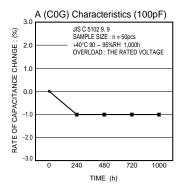
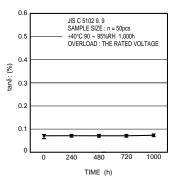


Fig.24 Insulation resistance

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.

### ■ Humidity load test





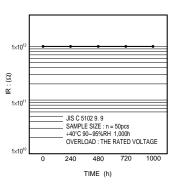
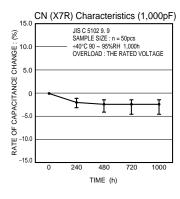
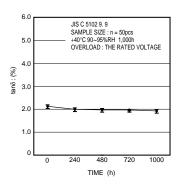


Fig.25 Rate of capacitance change

Fig.26  $tan \delta$ 

Fig.27 Insulation resistance





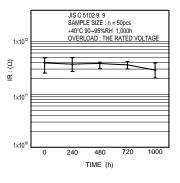
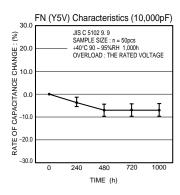
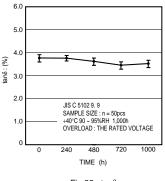


Fig.28 Rate of capacitance change

Fig.29 tanδ

Fig.30 Insulation resistance





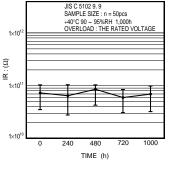


Fig.31 Rate of capacitance change

Fig.32 tanδ

Fig.33 Insulation resistance

<sup>\*</sup>The design and specifications are subject to change without prior notice. Before ordering or using, please check the latest technical specification.